APPLICA	BLE STAN	DARD												
	OPERATING TEMPERATURE RANGE OPERATING HUMIDITY RANGE APPLICABLE CONNECTOR		20% TO 80% (NOTE2) 20% TO 80% (NOTE2) DF57H-3S-1.2C(##) UL C-L		STORAG TEMPER		E RANGE	-10	-10 °C TO +60°C (NOTE3)					
RATING					STORAG	Y RANGE OPERATING TEMPERATURE		40%	40% TO 70% (NO					
					UL· C-UL RATING			-35 °	(NOTE	NOTE1)				
	APPLICABLE CONTACT		DF57-****SCF(##)			VOL	TAGE	29 V AC/DC						
	VOLTAGE CURRENT		50 V AC/DC AWG28 : 2.0A/PIN AWG30 : 1.5A/PIN AWG32 : 1.0A/PIN AWG34 : 0.8A/PIN		2	CUR	RENT		AWG28 : 2.0A/PIN AWG30 : 1.5A/PIN AWG32 : 1.2A/PIN AWG34 : 1.0A/PIN			l I		
			SPECI	FICA	NOITA	IS								
IT	EM		TEST METHOD				RE	QUIREMEN [®]	TS	C	ŢΩ	ΑT		
CONSTRI														
	EXAMINATION	VISUALLY AND BY MEASURING INSTRUMENT.				ACCORDING TO DRAWING.					X X	X		
MARKING	10 01 14 D 4	CONFIRMED VISUALLY.										Χ		
CONTACT R	IC CHARA		(, 1mA (DC or 1000Hz).		1 4	10 mΩ	MΔX				X			
MILLIVOLT LE	VEL METHOD	,												
VOLTAGE PROOF		100 V DC. 500 V AC FOR 1 min.				100 MΩ MIN. NO FLASHOVER OR BREAKDOWN.					X			
					N	U FLA	onuvek 0	r breakDOV	VIN.		X	_		
MECHANICA MECHANICA	NCAL CHA		ERISTICS INSERTION AND EXTRACTION	l <u>.</u>	141)CONIT	ACT RESIS	STANCE: 20 m	Ω ΜΔΥ	 ,	X	_		
OPERATION	٧					1)CONTACT RESISTANCE: 20 m Ω MAX. 2)NO DAMAGE, CRACK OR LOOSENESS OF PARTS.					^			
CONTACT I	NSERTION TION FORCES	IT TAKES OUT AND INSERTS WITH A CONFORMITY CONNECTOR.				1)INSERTION FORCE : 20.0N MAX. 2)EXTRACTION FORCE: 0.9N MIN.					X	_		
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE				1)NO ELECTRICAL DISCONTINUITY OF 1 μ s. 2)NO DAMAGE, CRACK OR LOOSENESS OF PARTS.					Χ	_		
SHOCK		0.75 mm, AT 10 CYCLES FOR 3 DIRECTION. 490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3									Χ	_		
ENI/IDON	IMENITAL C	DIRECTIO	NS. TERISTICS											
DAMP HEAT E		EXPOSED AT 40 ± 2°C, 90 TO 95 %, 96 h.			OR 1-2h.) 2	1)CONTACT RESISTANCE: $20 \text{ m}\Omega$ MAX. 2)INSULATION RESISTANCE: $100 \text{ M}\Omega$ MIN. 3)NO DAMAGE, CRACK OR LOOSENESS OF PARTS.					X	_		
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55°C→ +85°C TIME 30min→ 30min				1)CONTACT RESISTANCE: $20~\text{m}\Omega$ MAX. 2)INSULATION RESISTANCE: $100~\text{M}\Omega$ MIN. 3)NO DAMAGE, CRACK OR LOOSENESS OF PARTS.					X	_		
RESISTANCE SOLDERING I		1) REFLOW SOLDERING			N E.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.					X	_		
			SOLDERING TEMPERATURE : 245°C DURATION OF IMMERSION :SOLDERING, FOR 5 sec.			NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.					X	-		
NOTE2:NO CO NOTE3:APPL	ONDENSING. Y TO THE CONE	DITION OF L	ISING BY CURRENT. ONG TERM STORAGE FOR UND HUMIDITY RANGE IS APPLIE		RODUCTS	BEFO	RE MOUNT	ED ON PCB.		ED ON	I PC	В,		
COUN	IT DE	SCRIPTION	SCRIPTION OF REVISIONS DESIG			NED CHECKED					DA	ΤE		
1		DIS-H-00005763 HK. HAY			HK. HAYAS	YASHI		SZ.	SZ. ONO		0200)220		
REMARKS							APPROVI		. AKIYAMA	_)221		
							CHECKE		. UMEHARA)221		
Unless otherwise specified, refer			er to IEC 60512.			DESIGNED			KUMAZAWA KUMAZAWA	20120220				
Note QT:Qualification Test AT:Assurance Test X:Applicable Test					DRAWING NO.				ELC-343905-21-01					
HS.		SPECIFICATION SHEET			PART N			DF57H-3	DF57H-3P-1. 2V (21)					
	HIR	OSE EL	ECTRIC CO., LTD.	CTRIC CO., LTD.		NO.	CL6	66-0105	6-0105-0-21		`	1/1		